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APPLICATION NO.	FII	LING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
10/688,920	10/688,920 10/21/2003		Woo Hyun Kim	041501-5458-01	3193	
9629	7590	03/22/2005		EXAMINER		
		BOCKIUS LLP	DUONG, THOI V			
1111 PENNSYLVANIA AVENUE NW WASHINGTON, DC 20004				ART UNIT PAPER NUMBI		
				2871		

DATE MAILED: 03/22/2005

Please find below and/or attached an Office communication concerning this application or proceeding.

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Application No.	Applicant(s)
10/688,920	KIM ET AL.
Examiner	Art Unit
Thoi V. Duong	2871

Advisory Action	10/688,920 KIM ET AL.						
Before the Filing of an Appeal Brief	Examiner	Art Unit					
·	Thoi V. Duong	2871					
The MAILING DATE of this communication appe	ars on the cover sheet with the o	correspondence add	ress				
• •	·						
THE REPLY FILED <u>01 March 2005</u> FAILS TO PLACE THIS APPLICATION IN CONDITION FOR ALLOWANCE. 1. ☑ The reply was filed after a final rejection, but prior to filing a Notice of Appeal. To avoid abandonment of this application, applicant must timely file one of the following replies: (1) an amendment, affidavit, or other evidence, which places the application in condition for allowance; (2) a Notice of Appeal (with appeal fee) in compliance with 37 CFR 41.31; or (3) a Request for Continued Examination (RCE) in compliance with 37 CFR 1.114. The reply must be filed within one of the following time periods:							
 a) The period for reply expires <u>03</u> months from the mailing date of the final rejection. b) The period for reply expires on: (1) the mailing date of this Advisory Action, or (2) the date set forth in the final rejection, whichever is later. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the mailing date of the final rejection. Examiner Note: If box 1 is checked, check either box (a) or (b). ONLY CHECK BOX (b) WHEN THE FIRST REPLY WAS FILED WITHIN TWO 							
MONTHS OF THE FINAL REJECTION. See MPEP 706.07(f)).						
Extensions of time may be obtained under 37 CFR 1.136(a). The date on been filed is the date for purposes of determining the period of extension a CFR 1.17(a) is calculated from: (1) the expiration date of the shortened states above, if checked. Any reply received by the Office later than three months earned patent term adjustment. See 37 CFR 1.704(b). NOTICE OF APPEAL	nd the corresponding amount of the fee. atutory period for reply originally set in the s after the mailing date of the final rejection	The appropriate extension final Office action; or (2) on, even if timely filed, ma	on fee under 37 as set forth in (b) ay reduce any				
2. The reply was filed after the date of filing a Notice of Appeal, but prior to the date of filing an appeal brief. The Notice of Appeal was filed on A brief in compliance with 37 CFR 41.37 must be filed within two months of the date of filing the Notice of Appeal (37 CFR 41.37(a)), or any extension thereof (37 CFR 41.37(e)), to avoid dismissal of the appeal. Since a Notice of Appeal has been filed, any reply must be filed within the time period set forth in 37 CFR 41.37(a). AMENDMENTS							
3. The proposed amendment(s) filed after a final rejection, but prior to the date of filing a brief, will <u>not</u> be entered because (a) They raise new issues that would require further consideration and/or search (see NOTE below); (b) They raise the issue of new matter (see NOTE below); (c) They are not deemed to place the application in better form for appeal by materially reducing or simplifying the issues for							
appeal; and/or (d)☐ They present additional claims without canceling a NOTE: (See 37 CFR 1.116 and 41.33(a)).		jected claims.					
 4. The amendments are not in compliance with 37 CFR 1.1 5. Applicant's reply has overcome the following rejection(s) 	21. See attached Notice of Non-Co						
 Newly proposed or amended claim(s) would be a the non-allowable claim(s). 	llowable if submitted in a separate	, timely filed amendm	ent canceling				
7. For purposes of appeal, the proposed amendment(s): a) how the new or amended claims would be rejected is pro The status of the claim(s) is (or will be) as follows: Claim(s) allowed:	will not be entered, or b) will not be entered, or b) wided below or appended. ■ The properties of t	rill be entered and an	explanation of				
Claim(s) objected to: Claim(s) rejected: <u>25.</u> Claim(s) withdrawn from consideration:							
AFFIDAVIT OR OTHER EVIDENCE							
8. The affidavit or other evidence filed after a final action, be because applicant failed to provide a showing of good an and was not earlier presented. See 37 CFR 1.116(e).	ut before or on the date of filing a N d sufficient reasons why the affida	Notice of Appeal will <u>r</u> vit or other evidence i	<u>iot</u> be entered is necessary				
9. The affidavit or other evidence filed after the date of filing a Notice of Appeal, but prior to the date of filing a brief, will <u>not</u> be entered because the affidavit or other evidence failed to overcome <u>all</u> rejections under appeal and/or appellant fails to provide a showing a good and sufficient reasons why it is necessary and was not earlier presented. See 37 CFR 41.33(d)(1).							
10. ☐ The affidavit or other evidence is entered. An explanatio REQUEST FOR RECONSIDERATION/OTHER		•					
11. The request for reconsideration has been considered bu See Continuation Sheet.			nce because:				
12. Note the attached Information Disclosure Statement(s). 13. Other:		DEERT H. KIM					
	SUPERVISO	RY PATENT EXAMINE LOGY CENTER 2800	ER				

Continuation of 11. does NOT place the application in condition for allowance because: Applicant's arguments are not persuasive. As shown in Figs. 7 and 8, the data lines D2n-1 and D2n in the pad region, which is outside the cell region 3, have alternately extended lengths and as shown in Fig. 10, the data lines D2n-1 and D2n are at alternately different levels above the insulating substrate 21 since the data line D2n-1 is formed on the semiconductor layer 25' and the data line D2n is formed on the gate insulating layer 24 only.